

7N40

UTC UNISONIC TECHNOLOGIES CO., LTD

Preliminary

Power MOSFET

7A, 400V N-CHANNEL **POWER MOSFET**

DESCRIPTION

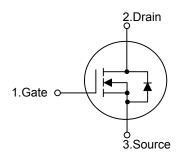
The UTC 7N40 is an N-channel mode power MOSFET using UTC's advanced technology to provide customers with planar stripe and DMOS technology. This technology specializes in allowing a minimum on-state resistance and superior switching performance. It also can withstand high energy pulse in the avalanche and commutation mode.

The UTC 7N40 is universally applied in electronic lamp ballast based on half bridge topology and high efficient switched mode power supply.

FEATURES

- * High switching speed
- * R_{DS(ON)}=0.9Ω @ V_{GS}=10V
- * 100% avalanche tested

SYMBOL

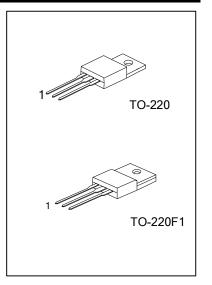


ORDERING INFORMATION

Ordering	Number	Daakaga	Pin Assignment		Decking	
Lead Free	Halogen Free	Package	1	2	3	Packing
7N40L-TA3-T	7N40G-TA3-T	TO-220	G	D	S	Tube
7N40L-TF1-T	7N40G-TF1-T	TO-220F1	G	D	S	Tube

Note: Pin Assignment: G: Gate D: Drain S: Source





■ ABSOLUTE MAXIMUM RATINGS (Tc=25°C, unless otherwise specified)

PAF	RAMETER	SYMBOL	RATINGS	UNIT
Drain-Source Voltage		V _{DSS}	400	V
Gate-Source Voltage		V _{GSS}	±30	V
Drain Current	Continuous (T _C =25°C)	Ι _D	7	А
	Pulsed (Note 2)	I _{DM}	28	А
Avalanche Current (No	ote 2)	I _{AR}	7.0	А
Avalanaha Enarav	Single Pulsed (Note 3)	E _{AS}	360	mJ
Avalanche Energy	Repetitive (Note 2)	E _{AR}	9.8	mJ
Peak Diode Recovery	dv/dt (Note 4)	dv/dt	4.5	V/ns
Dower Dissipation	TO-220		98	W
Power Dissipation	TO-220F1		39	W
Derate above 25°C	TO-220		0.78	W/°C
Derate above 25 C	TO-220F1		0.315	W/°C
Junction Temperature		TJ	+150	°C
Storage Temperature		T _{STG}	-55~+150	°C

Notes: 1. Absolute maximum ratings are those values beyond which the device could be permanently damaged. Absolute maximum ratings are stress ratings only and functional device operation is not implied.

2. Repetitive Rating: Pulse width limited by maximum junction temperature

- 3. L = 13mH, I_{AS} = 7A, V_{DD} = 50V, R_G = 25 Ω , Starting T_J = 25°C
- 4. $I_{SD} \le 7A$, di/dt $\le 200A/\mu s$, $V_{DD} \le BV_{DSS}$, Starting $T_J = 25^{\circ}C$

■ THERMAL DATA

PARAMETER		SYMBOL	RATINGS	UNIT
Junction to Ambient		θ _{JA}	62.5	°C/W
lunation to Coop	TO-220	0	1.28	°C 141
Junction to Case	TO-220F1	$\theta_{\rm JC}$	3.2	°C/W



■ ELECTRICAL CHARACTERISTICS (T_c=25°C, unless otherwise specified)

AX UNI	א MAX	N TYP	TEST CONDITIONS MIN	SYMBOL		PARAMETER
						OFF CHARACTERISTICS
V		00	I _D =250µA, V _{GS} =0V 400	BV _{DSS}	е	Drain-Source Breakdown Voltag
V/°C	3	0.43	Reference to 25°C, I _D =250µA	$\triangle BV_{DSS} / \triangle T_J$	e Coefficient	Breakdown Voltage Temperatur
1 µA	1		V _{DS} =400V, V _{GS} =0V	I _{DSS}		Drain-Source Leakage Current
100 nA	+100		V _{GS} =+30V, V _{DS} =0V		Forward	Cata, Sauraa Laakaga Currant
00 nA	-100		V _{GS} =-30V, V _{DS} =0V	I _{GSS}	Reverse	Gate- Source Leakage Current
						ON CHARACTERISTICS
.0 V	4.0	0	V _{DS} =V _{GS} , I _D =250µA 2.0	V _{GS(TH)}		Gate Threshold Voltage
.9 Ω	5 0.9	0.75	V _{GS} =10V, I _D =3.5A	R _{DS(ON)}	esistance	Static Drain-Source On-State Re
	_					DYNAMIC PARAMETERS
80 pF) 780	600		C _{ISS}		Input Capacitance
35 pF	5 135	105	V _{GS} =0V, V _{DS} =25V, f=1.0MHz	Coss		Output Capacitance
l7 pF	17	13		C _{RSS}		Reverse Transfer Capacitance
						SWITCHING PARAMETERS
22 nC	5 22	16.5		Q_{G}		Total Gate Charge
nC		4.5	V _{GS} =10V, V _{DS} =320V, I _D =7A	Q_{GS}		Gate to Source Charge
nC		8.5	(Note 1, 2)	Q_{GD}		Gate to Drain Charge
50 ns	50	20		t _{D(ON)}		Turn-ON Delay Time
60 ns	160	75	V _{DD} =200V, I _D =7A, R _G =25Ω	t _R		Rise Time
30 ns	80	35	(Note 1, 2)	t _{D(OFF)}		Turn-OFF Delay Time
10 ns	110	50		t _F		Fall-Time
			TICS	HARACTERIS [®]	NGS AND C	SOURCE- DRAIN DIODE RATI
7 A	7			ls	us Current	Maximum Body-Diode Continuo
28 A	28			I _{SM}	urrent	Maximum Body-Diode Pulsed C
.5 V	1.5		I _S =7A, V _{GS} =0V	V_{SD}	Itage	Drain-Source Diode Forward Vo
ns)	220	I _S =7A, V _{GS} =0V,	t _{rr}	Time	Body Diode Reverse Recovery
μC		1.3	dI _F /dt=100A/µs (Note 1)	Q _{RR}	Charge	Body Diode Reverse Recovery (
)	-	I _S =7A, V _{GS} =0V,	t _{rr}	Time Charge	Body Diode Reverse Recovery

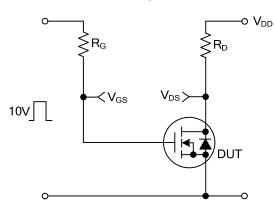
Notes: 1. Pulse Test: Pulse width \leq 300µs, Duty cycle \leq 2%

2. Essentially independent of operating temperature

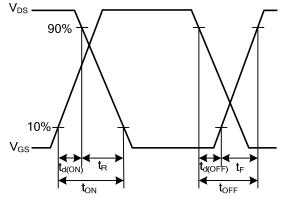
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■ TEST CIRCUITS AND WAVEFORMS

Resistive Switching Test Circuit



Resistive Switching Waveforms



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